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	O-1595		R SHEET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office
To the Honorable Commissioner of Patents and Tradellians, Frease record the attached original documents or copy thereof.			
1	Name of conveying party(ies):	2	Name and address of receiving party(ies):
	Feng-Yuan An Huan-Wen Wang		Taiwan Semiconductor Manufacturing Co. Ltt. No. 6. Li-Hsin Rd. 6 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.
3	Nature of conveyance: ■ Assignment		Additional name(s) & address(es) attached □ Yes No
	☐ Security Agreement ☐ Change of Name		
	Other: Execution Date: June 16, 2003		4-28-02
4	Application number(s) or patent number(s):	, et .	•
	If this document is being filed together with a new application,	, the	execution date of the application is: 06-16-03
	A. Patent Application No(s).		B. Patent No(s)
5	Additional numbers atta Name and address of party to whom correspondence concerning document should be mailed:	ache 6	ed? □ Yes ☒ No │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │ │
	RANDY W. TUNG Tung & Associates	7	Total fee (37 CFR 3.41) \$40.00
	838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302		□ Enclosed ☑ Authorized to charge credit card (w/filing fee)
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9	Statement and signature. To the best of my knowledge and belief, the foregoing information the original document. Randy W. Tung Name of Person Signing Signature	ation	is true and correct and any attached copy is a true copy of Oct. 2, 2003 Date
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Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

67,200-1101

ASSIGNMENT

WHEREAS, we, <u>FENG-YUAN AN and HUAN-WEN WANG</u>, have invented certain improvements in

AMORPHIZING ION IMPLANT METHOD FOR FORMING

POLYSILICON EMITTER BIPOLAR TRANSISTOR

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

REEL: 015295 FRAME: 0005

67,200-1101 2002-1145

patent, and in and to any patent applications which may be filed on said invention in countries

foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said

invention in its own name or through its designees, including subsidiaries, related companies or

assignees, under the International Convention or otherwise, and we further agree to execute all

papers, including those required for the United States and foreign applications, and to perform

such other proper acts as said corporation or its designees the rights herein assigned.

Feng-yuan An Huan-Wen Wang
Huan-Wen Wang

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302

RECORDED: 04/28/2004

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